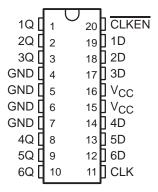
- Contains Six D-Type Flip-Flops
- Clock Enable Latched to Avoid False Clocking
- Applications Include: Buffer/Storage Registers, Shift Registers, Pattern Generators
- Flow-Through Architecture Optimizes PCB Layout
- Center-Pin V_{CC} and GND Pin Configurations Minimize High-Speed Switching Noise
- EPIC ™ (Enhanced-Performance Implanted CMOS) 1-μm Process
- 500-mA Typical Latch-Up Immunity at 125°C
- Package Options Include Plastic Small-Outline Packages, and Standard Plastic 300-mil DIPs

DW OR N PACKAGE (TOP VIEW)



description

These circuits are positive-edge-triggered D-type flip-flops with a clock-enable input. Information at the D inputs meeting the setup time requirements is transferred to the Q outputs on the positive-going edge of the clock pulse if the clock-enable input (CLKEN) is low.

Clock triggering occurs at a particular voltage level and is not directly related to the transition time of the positive-going pulse. When the clock inputs are at either the high or low level, the data (D) input signal has no effect at the output. The circuits are designed to prevent false clocking by transitions at the clock-enable (CLKEN) input.

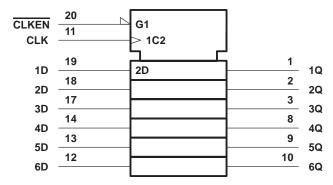
The 74AC11378 is characterized for operation from – 40°C to 85°C.

FUNCTION TABLE (each flip-flop)

IN	IPUTS	PUTS OUTF				
CLKEN	CLK	D	Q			
Н	Х	Χ	QO			
L	\uparrow	Н	Н			
L	\uparrow	L	L			
X	L	Χ	QO			

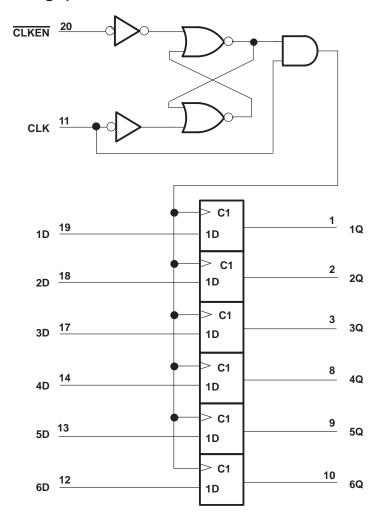
EPIC is a trademark of Texas Instruments Incorporated.

logic symbol†



 $[\]dagger$ This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)





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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}	
Input voltage range, V _I (see Note 1)	\dots -0.5 V to V _{CC} + 0.5 V
Output voltage range, VO (see Note 1)	$-0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$)	±20 mA
Output clamp current, I _{OK} (V _O < 0 or V _O > V _{CC})	±50 mA
Continuous output current, $I_O(V_O = 0 \text{ to } V_{CC})$	±50 mA
Continuous current through V _{CC} or GND pins	±150 mA
Storage temperature range	65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

recommended operating conditions

			MIN	NOM	MAX	UNIT
Vcc	Supply voltage		3	5	5.5	V
		V _{CC} = 3 V	2.1			
VIH	High-level input voltage	$V_{CC} = 4.5 \text{ V}$	3.15			V
V_{IH} High-level input voltage V_{IL} Low-level input voltage V_{I} Input voltage V_{O} Output voltage I_{OH} High-level output current I_{OL} Low-level output current $\Delta t/\Delta v$ Input transition rise or fall rate	$V_{CC} = 5.5 V$	3.85				
		V _{CC} = 3 V			0.9	
VIL	Low-level input voltage	$V_{CC} = 4.5 \text{ V}$			1.35	V
		$V_{CC} = 5.5 \text{ V}$			1.65	
٧ _I	Input voltage		0		VCC	V
٧o	Output voltage		0		VCC	V
		V _{CC} = 3 V			-4	
lOH	High-level output current	$V_{CC} = 4.5 \text{ V}$			-24	mA
	High-level input voltage Low-level input voltage Input voltage Output voltage High-level output current Low-level output current	$V_{CC} = 5.5 V$			-24	
		V _{CC} = 3 V			12	
lOL	Low-level output current	V _{CC} = 4.5 V			24	mA
		$V_{CC} = 5.5 V$			24	
Δt/Δν	Input transition rise or fall rate		0		10	ns/V
TA	Operating free-air temperature		-40		85	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	Vaa	T/	A = 25°C	;	MIN MA	MAX	LIMIT
PARAMETER	TEST CONDITIONS	vcc	MIN	TYP	MAX	IVIIIV	IVIAA	UNIT
			2.9			2.9		
	$I_{OH} = -50 \mu\text{A}$	4.5 V	4.4			4.4		
		5.5 V	5.4			5.4		
Voн	$I_{OH} = -4 \text{ mA}$	3 V	2.58			2.48		V
		4.5 V	3.94			3.8		V .1 .1 .1 .44 .44 .44 .45 .45 .44
	I _{OL} = – 24 mA	5.5 V	4.94			4.8		
	$I_{OH} = -75 \text{ mA}^{\dagger}$	5.5 V				3.85		
	I _{OL} = 50 μA	3 V			0.1		0.1	
		4.5 V			0.1		0.1	
					0.1		0.1	
VOL	$I_{OL} = 12 \text{ mA}$	3 V			0.36		0.44	V
		4.5 V			0.36		0.44	
	I _{OL} = 24 mA				0.36		0.44	
	$I_{OL} = 75 \text{ mA}^{\dagger}$	5.5 V					1.65	
IĮ	$V_I = V_{CC}$ or GND	5.5 V			±0.1		±1	μΑ
lcc	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			8		80	μΑ
Ci	$V_I = V_{CC}$ or GND	5 V		4	·			pF

[†] Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.

timing requirements over recommended operating free-air temperature range, V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

			T _A = 2	T _A = 25°C		MAX	UNIT	
			MIN	MAX	MIN	WAX	01411	
fclock	Clock frequency		0	90	0	90	MHz	
t _W	Pulse duration	CLK high or low	5.5		5.5		ns	
	Setup time, before CLK↑	Data	8		8			
t _{su}	Setup time, before CENT	CLKEN high or low	6.5		6.5		ns	
	Hold time_after CLK↑	Data	0		0			
t _h		CLKEN high or low	0		0		ns	

timing requirements over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

			T _A = 2	25°C	MIN	MAX	UNIT
			MIN	MAX	IVIIIV	IVIAA	UNIT
fclock	Clock frequency		0	110	0	110	MHz
t _W	Pulse duration	CLK high or low	4		4		ns
	Setup time, before CLK↑	Data	5		5		
t _{su}	Setup time, before CLK1	CLKEN high or low	4.5		4.5		ns
4.	Hold time, after CLK↑ Data CLKEN h	Data	0		0		no
th		CLKEN high or low	0				ns

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switching characteristics over recommended operating free-air temperature range, V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	T,	Վ = 25°C	;	MIN	MAX	UNIT
	(INPUT)	(OUTPUT)	MIN	MIN TYP	MAX	IVIIIV	WAX	UNIT
f _{max}			90	115		90		MHz
t _{PLH}	CLK	Any Q	3	7.6	9.5	3	10.9	no
t _{PHL}		Ally Q	3.6	9.8	12.8	3.6	14	ns

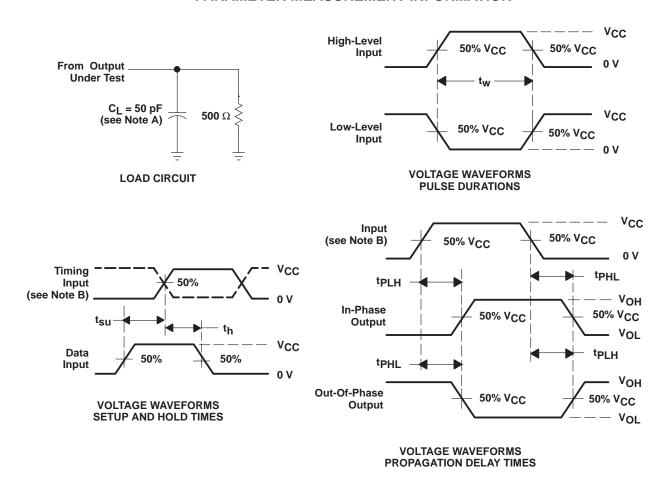
switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	T _A = 25°C	MAX	UNIT			
PARAIVIETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	IVIIIV	IVIAX	UNII
f _{max}			110	140		110		MHz
^t PLH	CLK	Any Q	2.4	4.3	7	2.4	7.7	
t _{PHL}	J CLK		3	6.2	8.8	3	9.7	ns

operating characteristics, V_{CC} = 5 V, T_A = 25°C

	PARAMETER	TEST CONDITIONS T		UNIT
Cpd	Power dissipation capacitance	$C_L = 50 \text{ pF}, \qquad f = 1 \text{ MHz}$	30	pF

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_I includes probe and jig capacitance.

- B. Input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, $t_f = 3 \text{ ns}$, $t_f = 3 \text{ ns}$.
- C. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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